

Product Change Notification / JAON-05VXDE987

Date:

10-May-2021

Product Category:

Simple and Complex Programmable Logic

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4257 Final Notice: Qualification of GTK as a new assembly site for selected ATML ATF22Lxx, ATF22Vxx, and ATF750xx device families available in 24L SOIC (300mils) package.

Affected CPNs:

JAON-05VXDE987_Affected_CPN_05102021.pdf JAON-05VXDE987_Affected_CPN_05102021.csv

Notification Text:

PCN Status: Final notification.

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open one of the files found in the Affected CPNs section.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change: Qualification of GTK as a new assembly site for selected ATML ATF22Lxx, ATF22Vxx, and ATF750xx device families available in 24L SOIC (300mils) package.

Pre and Post Change Summary:

	Pre Change	Post Change				
Assembly Site	Lingsen Precision Industries, LTD. (LPI)	Greatek Electronic Inc. (GTK)				

Bond W	'ire material	Gold (Au)	Gold (Au)						
Die atta	nch material	CRM-1033BF	EN-4900GC						
Molding compound material		G600	G600						
Lead frame material		A194	A194						
Pad	dle Size	145 x 158 mils 190 x 220 mils				145 x 158 mils 190 x 220 mils			
MSL CI	assification	MSL 2 MSL 3							
	Tube Color	Clear	Clear						
Packing Media:	Plug Color	Black/Black	Blue/White						
Tube	Tube Dimensions	Minor dimensional changes. See pre and post change comparison							

Impacts to Data Sheet: None

Change Impact:None

Reason for Change:To improve on-time delivery performance by qualifying GTK as a new assembly site.

Change Implementation Status: In Progress

Estimated First Ship Date:

June 10, 2021 (date code: 2124)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	June 2020			→	May 2021			June 2021								
Workweek	2 3	2 4	2 5	2 6	2 7		18	19	20	21	22	23	24	25	26	27
Initial PCN Issue Date		Х														
Qual Report Availability									х							
Final PCN Issue Date									Х							
Estimated Implementation Date													Х			

Method to Identify Change: Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History:June 9, 2020: Issued initial notification.

May 10, 2021: Issued final notification. Attached the Qualification Report. Revised the affected parts list. Provided estimated first ship date to be on June 10, 2021.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_JAON-05VXDE987_Pre and Post Change_Summary.pdf PCN_JAON-05VXDE987_Qual_Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. JAON-05VXDE987 - CCB 4257 Final Notice: Qualification of GTK as a new assembly site for selected ATML ATF22Lxx, ATF22Vxx, and ATF750xx device families available in 24L SOIC (300mils) package.

Affected Catalog Part Numbers (CPN)

ATF750C-7SX ATF750LVC-15SU ATF750CL-15SU ATF750C-10SU ATF750C-10SU-T ATF22V10C-7SX ATF22V10C-10SU ATF22LV10C-10SU-T ATF22V10CQZ-20SU ATF22LV10CQZ-20SU-T